

TOSHIBA HIGH EFFICIENCY DIODE STACK (HED) SILICON EPITAXIAL TYPE

20DL2CZ47A, 20FL2CZ47A

SWITCHING TYPE POWER SUPPLY APPLICATION

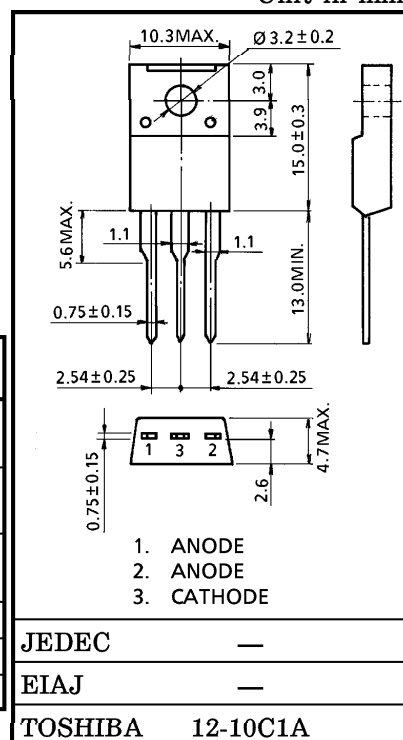
CONVERTER & CHOPPER APPLICATION

Unit in mm

- Repetitive Peak Reverse Voltage : $V_{RRM}=200, 300V$
- Average Output Rectified Current : $I_O=20A$
- Ultra Fast Reverse-Recovery Time : $t_{rr}=35ns$ (Max.)
- Low Switching Losses and Low Output Noise.

MAXIMUM RATINGS ($T_a = 25^\circ C$)

CHARACTERISTIC		SYMBOL	RATING	UNIT
Repetitive Peak Reverse Voltage	20DL2CZ47A	V _{RRM}	200	V
	20FL2CZ47A		300	
Average Output Rectified Current (Full Sine Waveform)		I _O	20	A
Peak One Cycle Surge Forward Current (Non-Repetitive)		I _{FSM}	100 (50Hz)	A
			110 (60Hz)	
Junction Temperature		T _j	−40~150	°C
Storage Temperature Range		T _{stg}	−40~150	°C
Screw Torque		—	0.6	N·m

ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ C$)

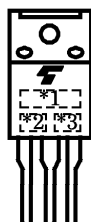
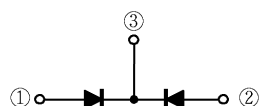
Weight : 2.0g

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Peak Forward Voltage (Note 1)	20DL2CZ47A	V_{FM}	$I_{FM}=10A$	—	—	0.98	V
	20FL2CZ47A			—	—	1.3	
Repetitive Peak Reverse Current (Note 1)		I_{RRM}	$V_{RRM} = \text{Rated}$	—	—	50	μA
Reverse Recovery Time (Note 1)		t_{rr}	$I_F = 2.0A, di/dt = -50A/\mu s$	—	—	35	ns
Forward Recovery Time (Note 1)		t_{fr}	$I_F = 1.0A$	—	—	100	ns
Thermal Resistance		$R_{th(j-c)}$	DC Total, Junction to Case	—	—	3.0	$^\circ C/W$

(Note 1) A value of one cell.

POLARITY

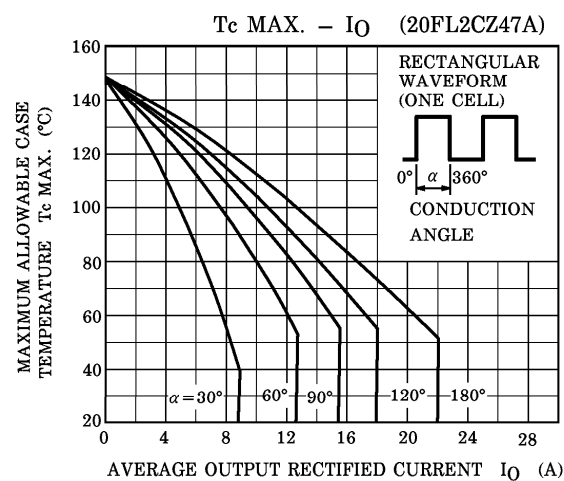
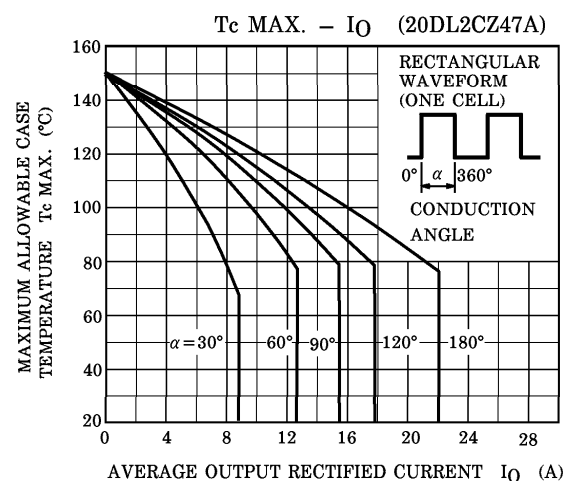
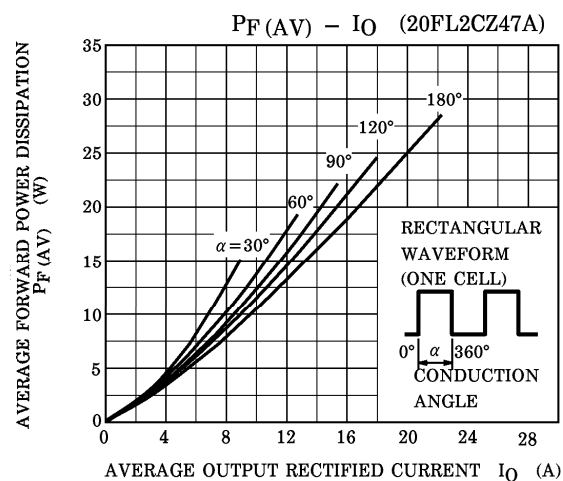
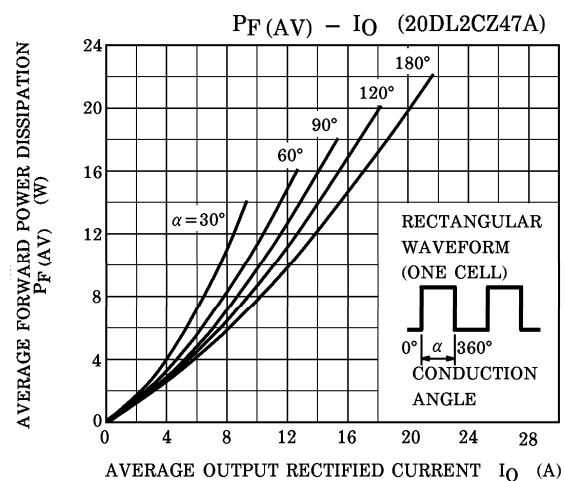
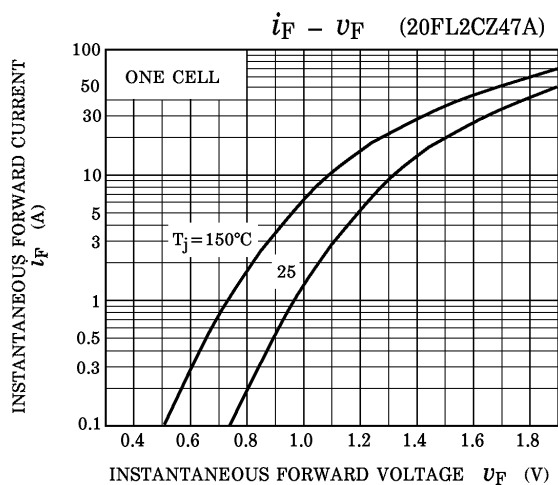
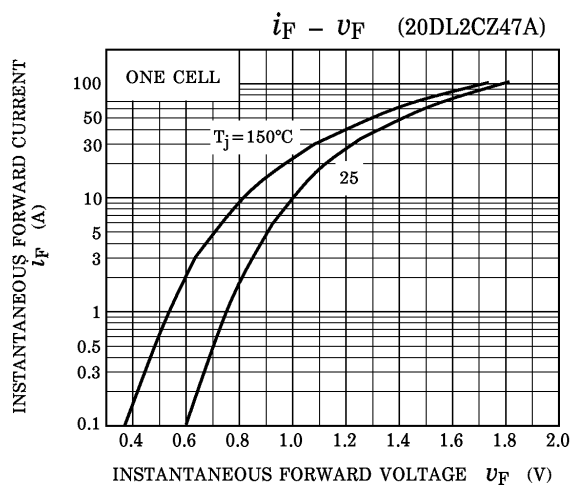
MARKING



*1	MARK	20DL2CZ	TYPE	20DL2CZ47A
		20FL2CZ		20FL2CZ47A
*2	A			
*3	Lot Number			
	Month (Starting from Alphabet A) Year (Last Number of the Christian Era)			

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